	`		01-3	1 - 2006		
	FORM PTO-1595				EET	U.S. DEPARTMENT OF COMM
-	©2005 Staas & Halsey LLP To the Director of th	e U.S. Patent and m	1031	67862	d documen	 t.
	Name of conve Yasushi YUI Shingo YAMAO Hiroshi TAKAH Kouhei CYOUI	IASHI				
	Name and Add	lress of receivin	g party(ies):			
	FUJITSU LIMI 1-1, Kamikoda Nakahara-ku, I Kanagawa 21	naka 4-chome Kawasaki-shi				
	Other:	ment y Agreement	2006	Merger Change of Nan	ne	
	Execution Date(s): January 6, 2006 Application number(s) or patent number(s): This document is being filed together with a new application. OR					
	(a) Patent		ed after filing os)., filed; or	of the application	1:	
	STAAS & HAL Attention: <u>H. J</u>	SEY _{LLP} <u>. Staas</u> ‹ Ave., N.W., Su			rning docu cket: <u>1614.</u>	ment should be mailed 1558
	Total number of	of applications a	nd patents in	volved: <u>1</u>		
	Total fee (37 CFR 3.41) (\$ 40.00 per Patent or Application in Assignment) ☐ Enclosed ☐ Authorized to be charged to deposit account.					
	Deposit Account No.: 19-3935 (Any underpayment is authorized to be charged to this Depos Account) (Attach duplicate copy of this page if paying by deposit account)					
	taas, Reg. No. 2 of Person Signii		S	ignature		<u>January 23, 2006</u> Date
			DO NOT USE		er of pages	s including cover shee
BETEM	1A1 00000068 113376	40.00 OP	7 . i			
		7V. VV UP				

PATENT REEL: 017501 FRAME: 0976

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar inventor(s) (hereinafter, "ASSIGNOR") by (Insert Name(s) & Address(es) of ASSIGNEE(S)) FUJITSU LIMITED	(\$1.00), and of other good and valuable o	onsideration paid to the undersigned
1-1, Kamikodanaka 4-chome, Nakahara-ku, Kawasa	ki-shi, Kanagawa 211-8588 Japan	
(hereinaster, "ASSIGNEE"), the receipt of which is her ASSIGNEE the entire and exclusive right, title and into	reby acknowledged, the undersigned ASSIGN erest to the invention entitled	OR hereby sells, assigns and transfers to
MOLDED RESIN OBJECT, ELECTRONIC INSTRU	MENT USING THE SAME, AND METHOD	OF PROCESSING A MOLDED
RESIN OBJECT		
relating to International Patent Application PCT/JP executed on even date herewith or, if not so executed,		or Letters Patent of the United States was
(a) executed on	; (Insert date of execution of applic	cation, if not concurrent)
(b) filed on;	Assignee's attorney is hereby data, when known.	authorized to insert in (b) the specified
and to said application and all Letters Patent(s) of the substitute, reissue or reexamination application based t including any extensions thereof (collectively, hereina The ASSIGNOR agree(s), when requested by said which the ASSIGNEE may deem necessary, desirable	thereon, for the full term or terms for which the ifter, "said application(s) and Letters Patent(s)" ASSIGNEE and without charge to but at the e	said Letters Patent(s) may be granted and '). xpense of said ASSIGNEE, to do all acts
including in the preparation and prosecution of said ar reexamination, or public use proceeding, and in any liti acts to include but not be limited to executing all pape sworn testimony, and obtaining and producing evidence	pplication(s) and the issuance of said Letters Prigation or other legal proceeding which may arrows, including separate assignments and declara	atent(s), in any interference, reissue, ise or be declared in relation to same, such
IN WITNESS WHEREOF, the undersigned invent		
1)	Yasushi Yui	2566. 1.6
(Signature) (2) 上) 口 損 舌	(Type Name) Shingo Yamaguchi	(Date) 2006: 1. 6
in 作 发	(Type Name) Hiroshi Takahashi	(Date) 2006./.6
(Signature) 4) 長東 ム甲	(Type Name) Kouhci Cyouraku	(Date) 2006, 1, 6
(Signature)	(Type Name)	(Date)
5)(Signature)	(Type Name)	(Date)

RECORDED: 01/24/2006

PATENT REEL: 017501 FRAME: 0977